



1473006-1 Product Details

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TE Internal Number: 1473006-1

Active

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Memory Sockets

Converted to EU RoHS/ELV Compliant (Statement of Compliance)

Product Highlights:

- Socket Type = Memory Card
- Socket Style = SO DIMM
- Gold Flash Contact Plating, Mating Area, Material
- 200 Positions
- DRAM Type = Double Data Rate (DDR)

[View all Features](#)

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Documentation & Additional Information

Product Drawings:

- [DDR1 & DDR2 SODIMM SOCKET 0.6mm PITCH 200POS STANDAR... \(PDF, English\)](#)

Catalog Pages/Data Sheets:

- None Available

Product Specifications:

- [DDR S.O.DIMM Socket 200 Positions \(PDF, English\)](#)

Application Specifications:

- None Available

Instruction Sheets:

- None Available

CAD Files: (CAD Format & Compression Information)

- [2D Drawing \(DXF, Version M1\)](#)
- [3D Model \(IGES, Version M1\)](#)
- [3D Model \(STEP, Version M1\)](#)

Additional Information:

- [Product Line Information](#)

Related Products:

- [Tooling](#)

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Product Features (Please use the Product Drawing for all design activity)

Product Type Features:

- Socket Style = SO DIMM
- DRAM Type = Double Data Rate (DDR)
- PCB Mount Style = Surface Mount
- Module Orientation = Right Angle
- Profile = Standard

Electrical Characteristics:

- DRAM Voltage = 2.5 V

Termination Features:

- Insertion Style = Cam-In
- Solder Tail Contact Plating = Gold Flash

Body Features:

- Socket Type = Memory Card
- Row-to-Row Spacing (mm [in]) = 6.20 [0.244]
- Ejector Type = Locking
- Ejector Location = Both Ends
- Latch Material = Stainless Steel
- Latch Plating = Tin
- Boss = With
- Mount Type = Printed Circuit Board

Contact Features:

- Contact Plating, Mating Area, Material = Gold Flash
- Contact Base Material = Copper Alloy

Housing Features:

- Centerline (mm [in]) = 0.60 [0.024]
- Housing Material = High Temperature Thermoplastic
- Housing Color = Black
- UL Flammability Rating = UL 94V-0

Configuration Features:

- Number of Positions = 200
- Stack Height (mm [in]) = 5.20 [0.205]
- Number of Rows = Dual
- Center Key (mm [in]) = None
- Number of Keys = 1

Industry Standards:

- RoHS/ELV Compliance = RoHS compliant, ELV compliant
- Lead Free Solder Processes = Reflow solder capable to 245°C, Reflow solder capable to 260°C
- RoHS/ELV Compliance History = Converted to comply with RoHS directive

Identification Marking:

- Keying = Reverse

Operation/Application:

- Application Type = DDR SDRAM

Packaging Features:

- Packaging Method = Semi-Hard Tray Assembly
- Packaging Quantity = 20

Other:

- Brand = AMP

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